

Title: SUBMINIATURE ELECTRICAL CONNECTOR
MULTI-PIN GROUNDING/DISCRETE CIRCUIT
BUSSING MODULE AND INTEGRAL CONNECTOR
BACKSHELL

Inventor: Joseph A. LOMASTRO et al

Appl. No. : New Application

Docket No.: 108324-00003

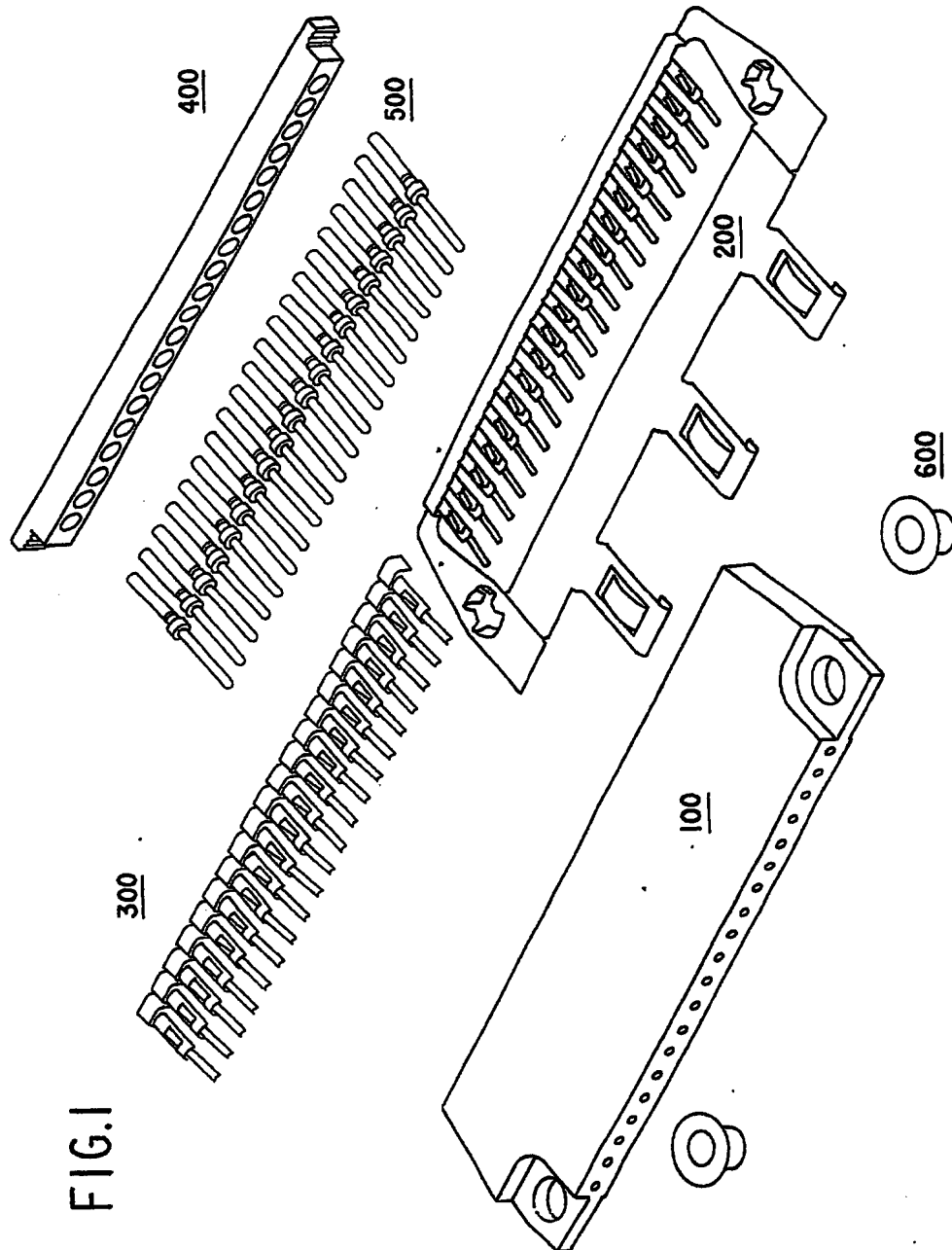


FIG.2

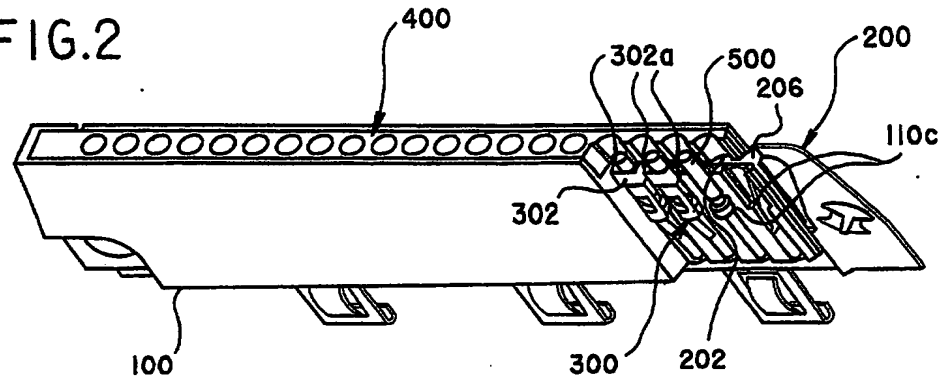


FIG.3A

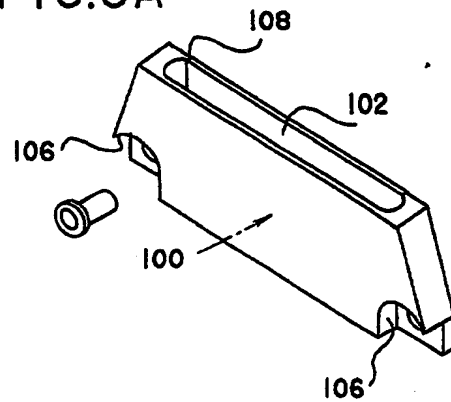


FIG.3B

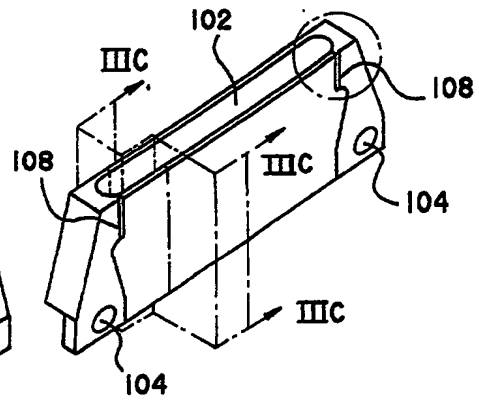


FIG.3C

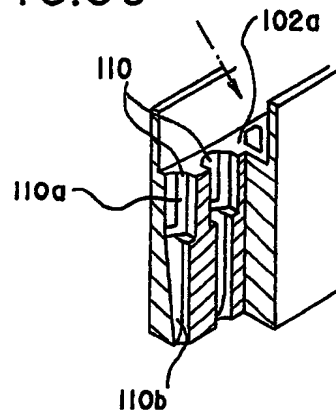
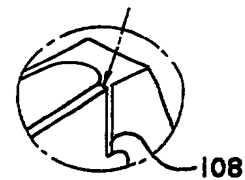
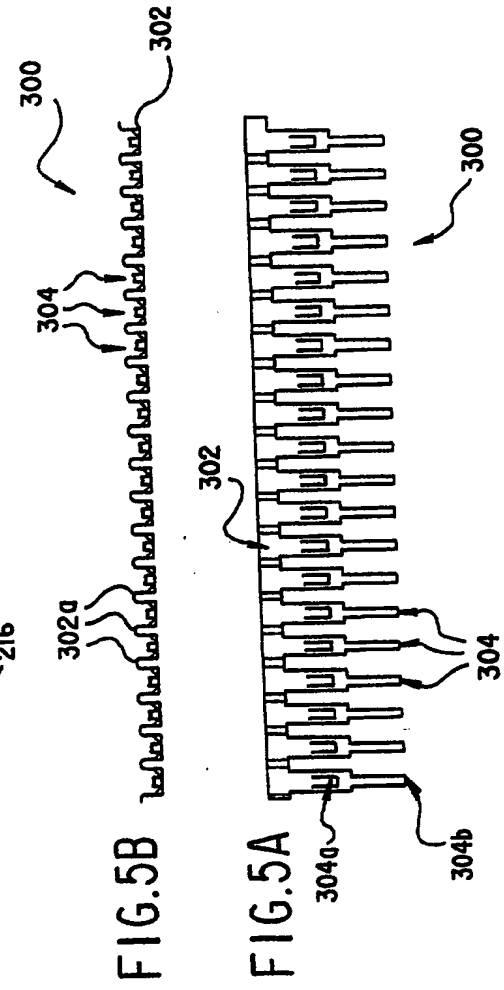
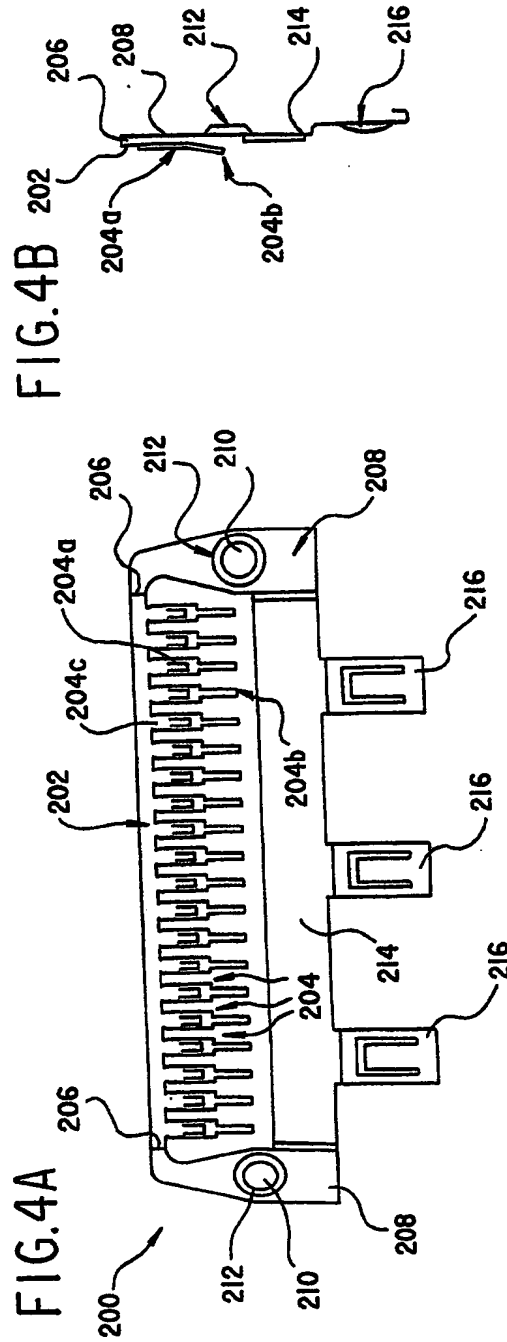


FIG.3D





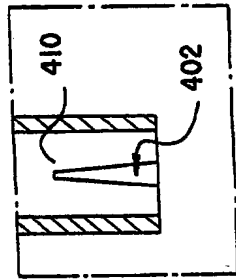


FIG. 6D

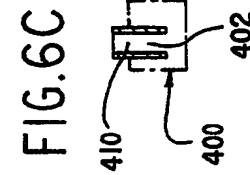


FIG. 6C

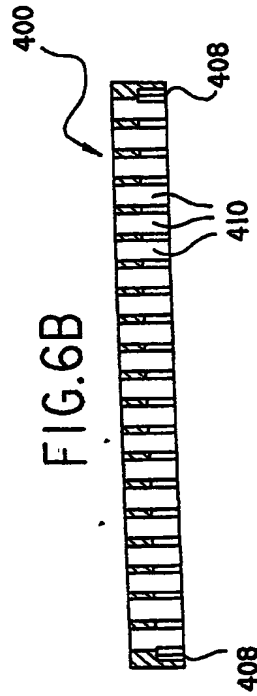


FIG. 6B

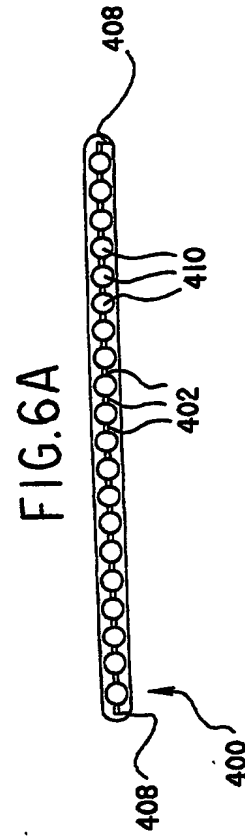
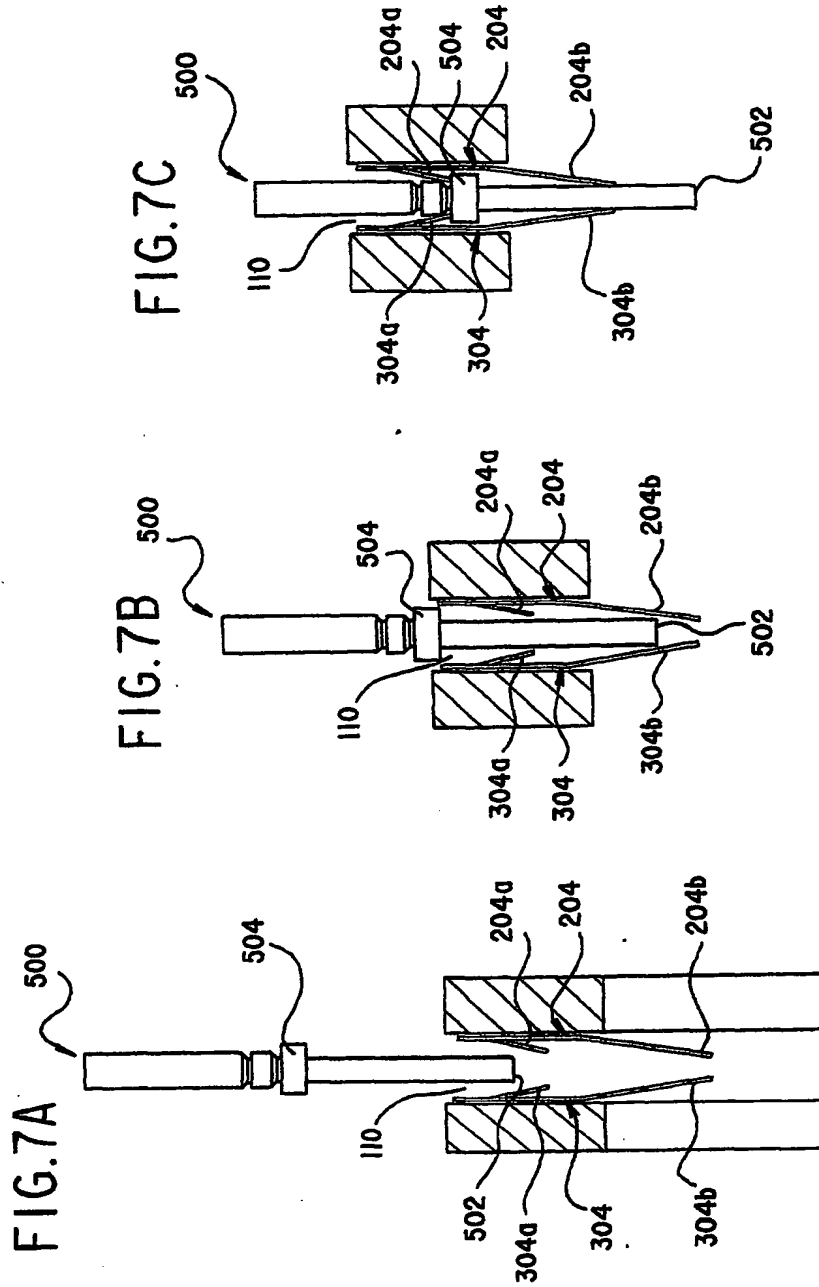


FIG. 6A



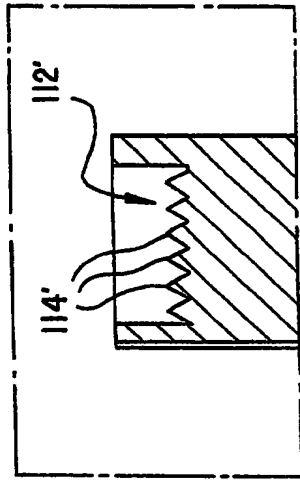


FIG. 8D

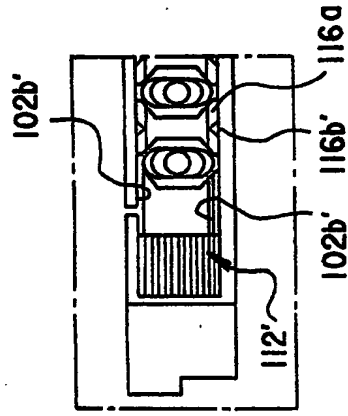


FIG. 8E

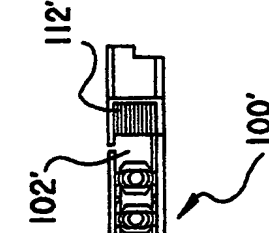
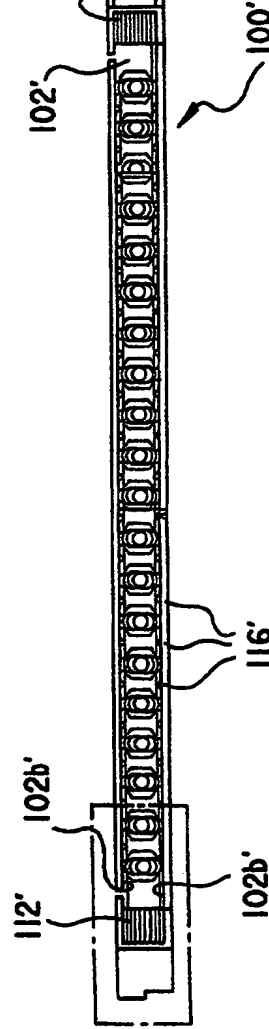
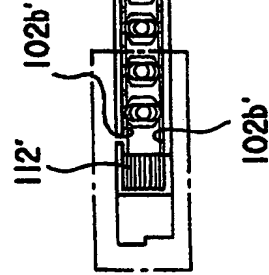


FIG. 8A

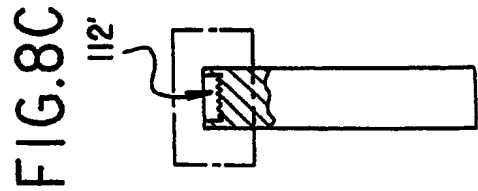


FIG. 8C

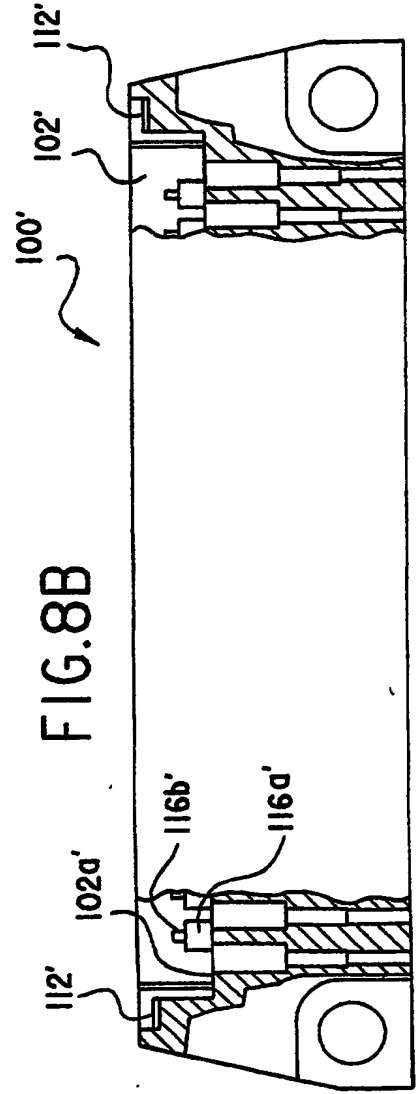
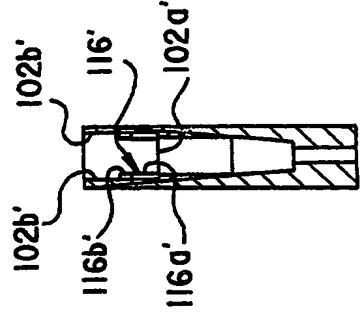
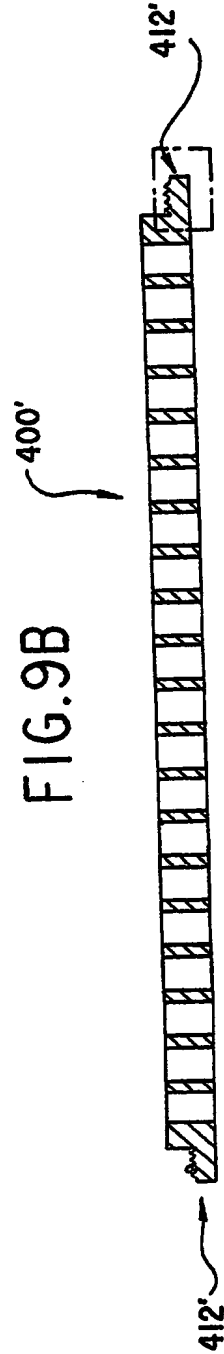
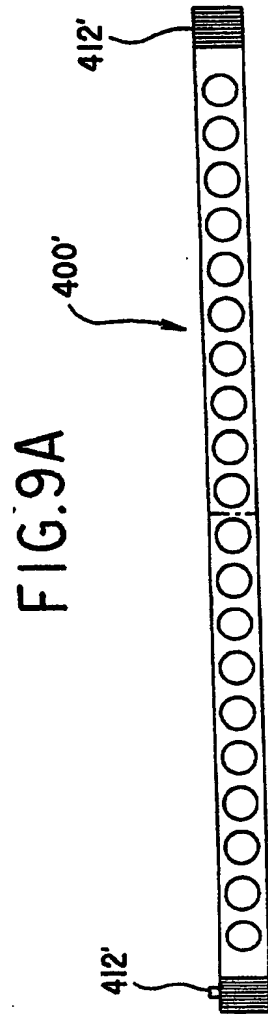
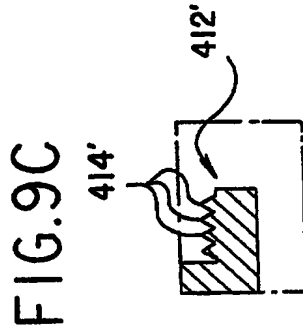


FIG. 8B

FIG. 8F





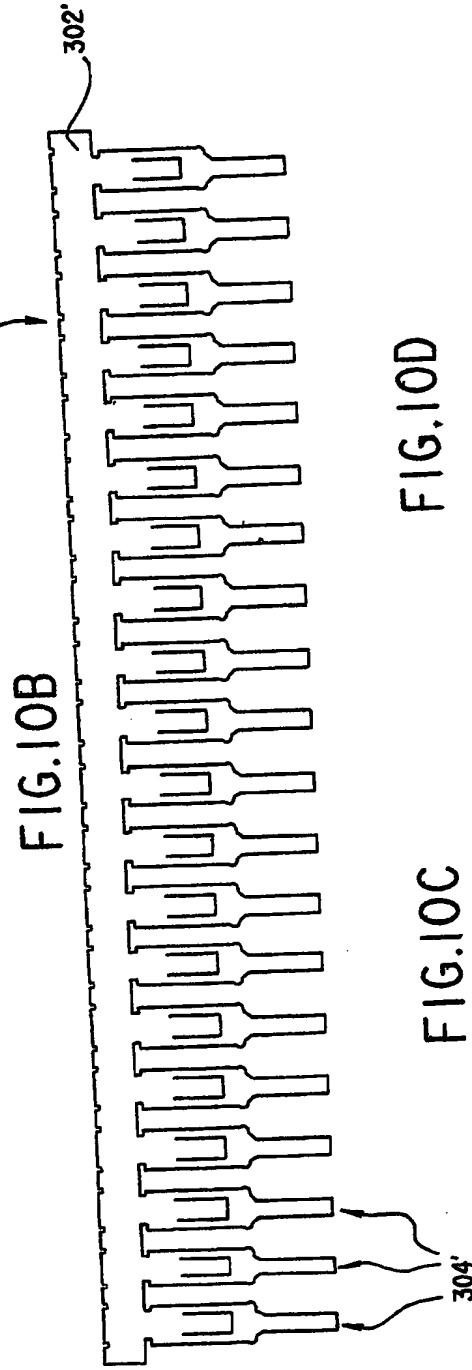
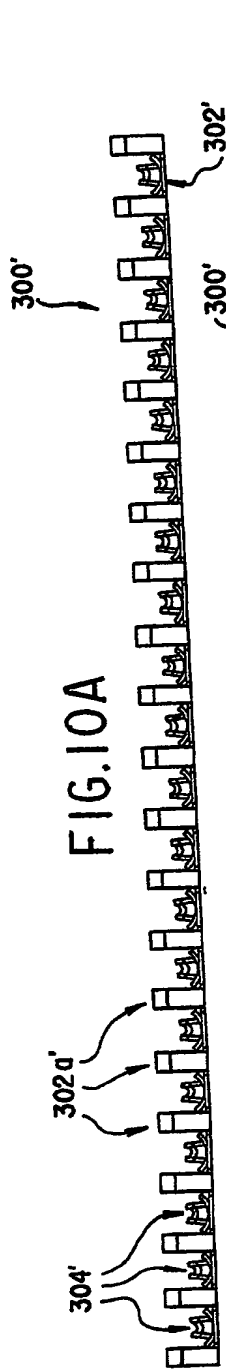


FIG. 10D

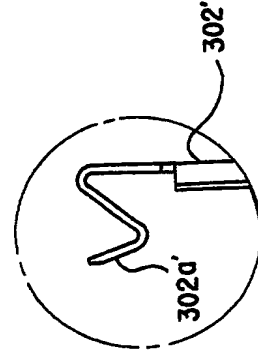
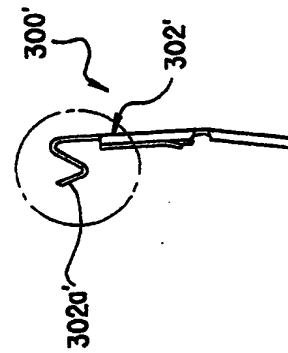


FIG. 10C



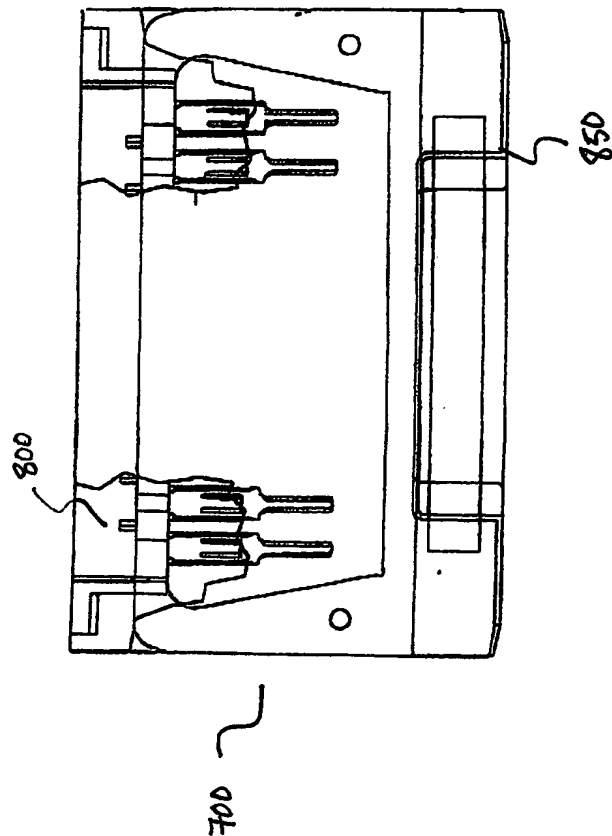


Fig. 11A

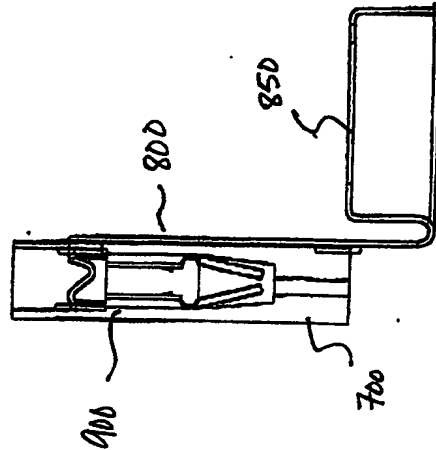
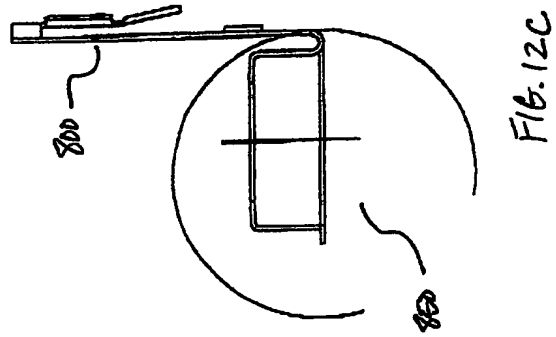
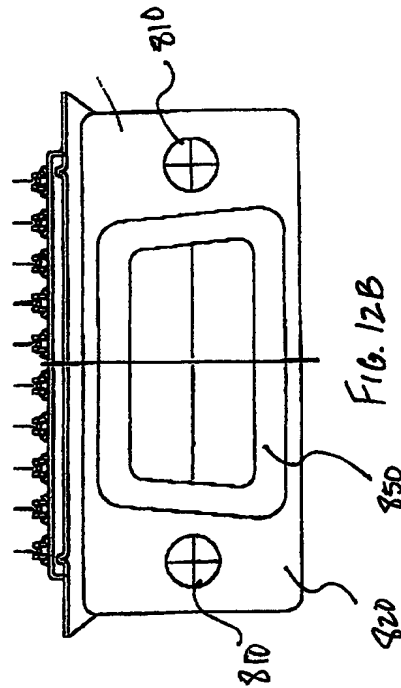
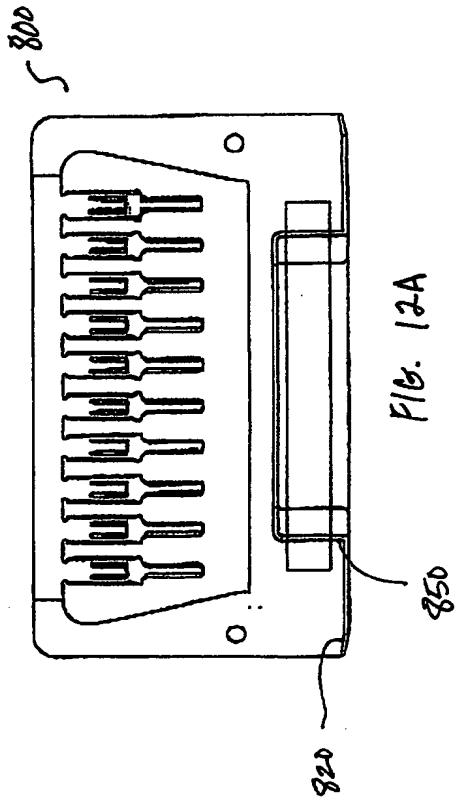


Fig. 11B



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